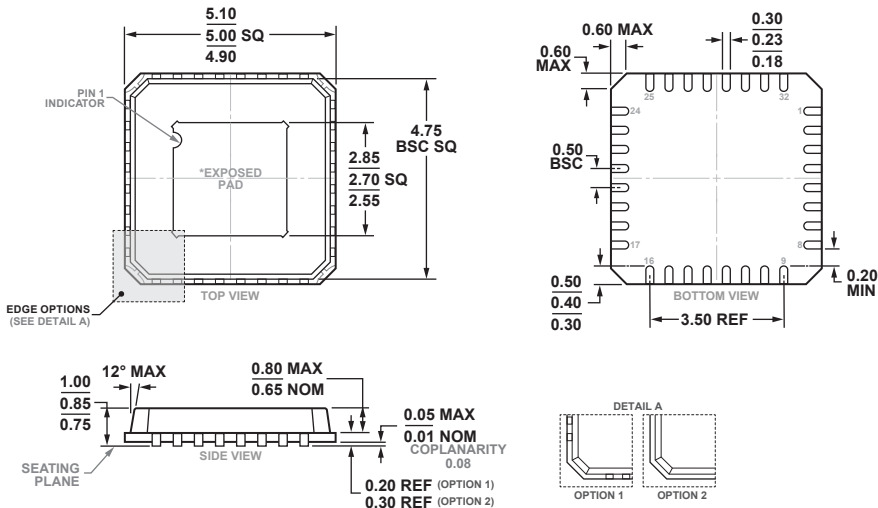


**32-Lead, Pad-Up, Lead Frame Chip Scale Package [LFCSP]
5 x 5 mm Body and 0.85 mm Package Height
(CP-32-1)**

Dimensions shown in millimeters



*COMPLIANT TO JEDEC STANDARDS MO-220-VHHD-2 WITH EXCEPTION TO PADDLE ORIENTATION. FOR PROPER CONNECTION OF THE EXPOSED PAD, REFER TO THE PIN CONFIGURATION AND FUNCTION DESCRIPTIONS SECTION OF THIS DATA SHEET.